
Multilayer Ceramic Capacitor



Multilayer Ceramic Capacitor

■ INTRODUCTION

MLCC(Multilayer Ceramic Capacitor) is SMD(Surface Mounted Device) type capacitor that is used in wide ranges of capacitance. MLCC is paid more attentions than other capacitors due to the better frequency characteristics, higher reliability, higher withstanding voltage and so on.

MLCC is made of many layers of ceramic and inner electrodes like sandwich. Pd was used for inner electrodes. But the price of Pd was skyrocketed and Pd was replaced by the BME(Base Metal Electrode), which reduced the total cost of MLCC.

This inner electrode is connected to outer termination for surface mounting, which is composed of three layers, Cu or Ag layer, Ni plating layer, and SnPb or Sn plating layer. Most of MLCCs become Pb free by the environmental issue at present.

MLCC is divided into two classes. Class I(C0G, etc) is the temperature compensating type. It has a small TCC(Temperature Coefficient of Capacitance) and a better frequency performance. Therefore, it is used in RF applications such as cellular phone, tuner, and so on. Class II(X7R, X5R, Y5V, etc) is the high dielectric constant type, which is used in general electronic circuit. Especially high capacitance MLCC is replacing other capacitors (Tantalum and Aluminum capacitor) due to the low ESR(Equivalent Series Resistance) value.

■ FEATURE AND APPLICATION

● Feature

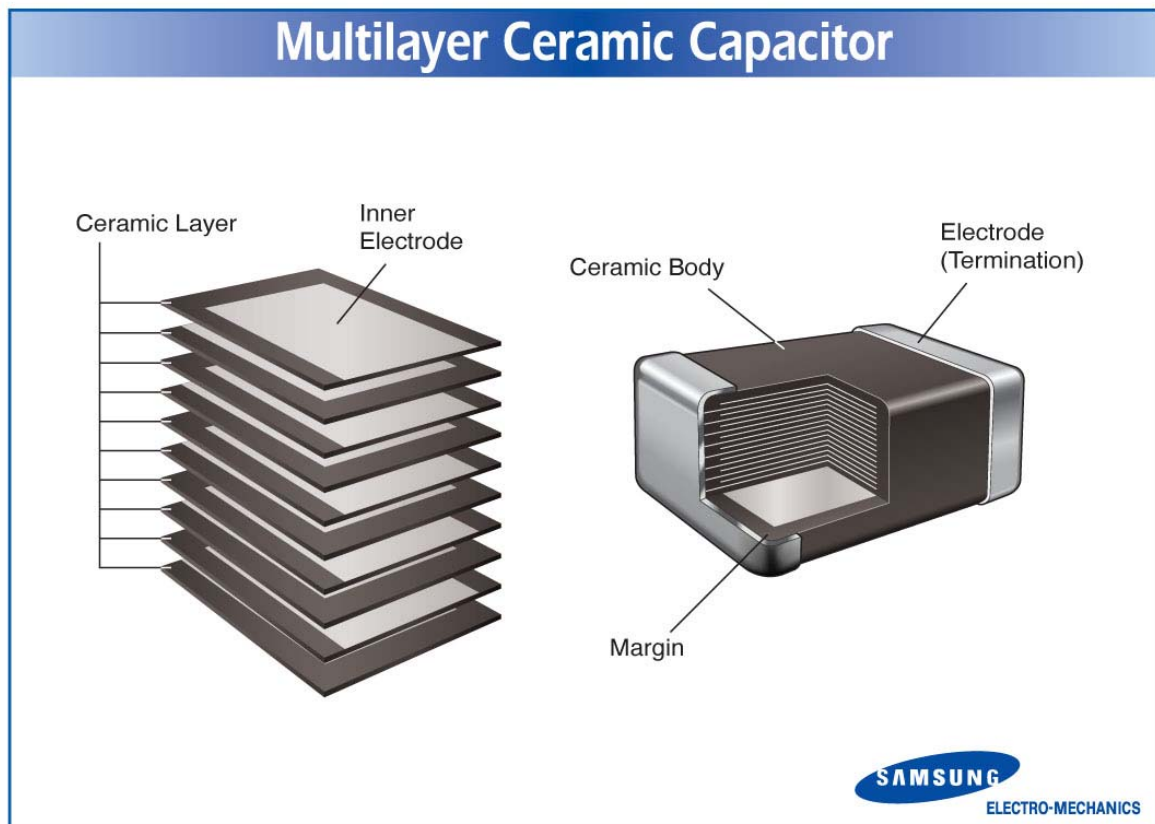
- Miniature Size
- Wide Capacitance and Voltage Range
- Highly Reliable Performance
- Tape & Reel for Surface Mount Assembly
- Low ESR
- High Q at High Frequencies
- Stable Temperature Dependence of Capacitance

● Application

- High Frequency Circuit(Tuner, VCO, PAM etc)
- General Power Supply Circuit(SMPS etc)
- DC-DC Converter
- General Electronic Circuit

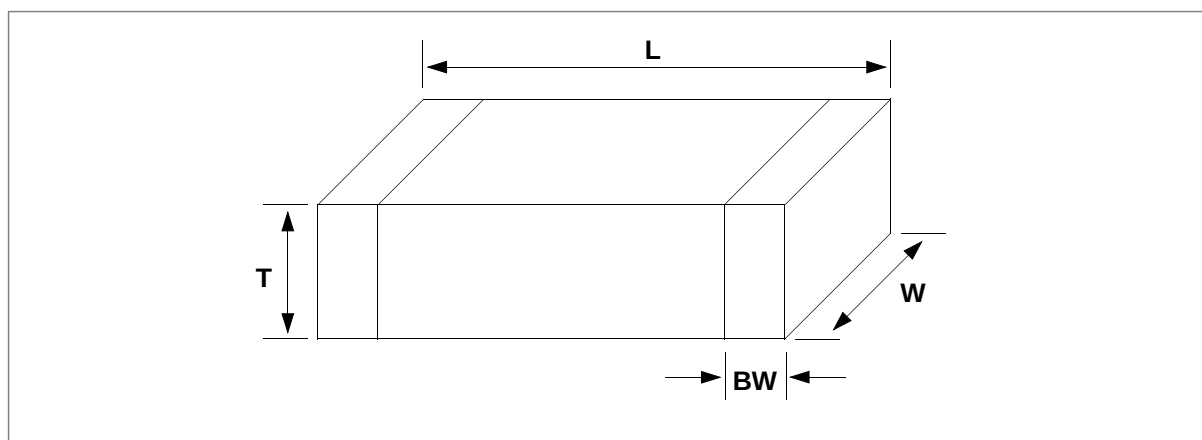
Multilayer Ceramic Capacitor

■ STRUCTURE



Multilayer Ceramic Capacitor

■ APPEARANCE AND DIMENSION



CODE	EIA CODE	DIMENSION (mm)			
		L	W	T (MAX)	BW
03	0201	0.6 ± 0.03	0.3 ± 0.03	0.3 ± 0.03	0.15 ± 0.05
05	0402	1.0 ± 0.05	0.5 ± 0.05	0.5 ± 0.05	$0.2 + 0.15 / - 0.1$
10	0603	1.6 ± 0.1	0.8 ± 0.1	0.8 ± 0.1	0.3 ± 0.2
21	0805	2.0 ± 0.1	1.25 ± 0.1	1.25 ± 0.1	$0.5 + 0.2 / - 0.3$
31	1206	3.2 ± 0.2	1.6 ± 0.2	1.6 ± 0.2	$0.5 + 0.2 / - 0.3$
32	1210	3.2 ± 0.3	2.5 ± 0.2	2.5 ± 0.2	0.6 ± 0.3
43	1812	4.5 ± 0.4	3.2 ± 0.3	3.2 ± 0.3	0.8 ± 0.3
55	2220	5.7 ± 0.4	5.0 ± 0.4	3.2 ± 0.3	1.0 ± 0.3

Multilayer Ceramic Capacitor

PREVIOUS PART NUMBERING

<u>CL</u>	<u>10</u>	<u>C</u>	<u>101</u>	<u>J</u>	<u>B</u>	<u>N</u>	<u>C</u>
①	②	③	④	⑤	⑥	⑦	⑧

- ① SAMSUNG Multilayer Ceramic Capacitor
- ② Type(Size)
- ③ Capacitance Temperature Characteristics
- ④ Nominal Capacitance
- ⑤ Capacitance Tolerance
- ⑥ Rated Voltage
- ⑦ Thickness Option
- ⑧ Packaging Type

③ CAPACITANCE TEMPERATURE CHARACTERISTICS

► CLASS I (Temperature Compensation)

Symbol	EIA Code	Temperature Coefficient(PPM/°C)	※ Temperature Characteristics	Operation Temperature Range
C	C0G(CH)	0 ± 30	CΔ	-55 ~ +125°C
P	P2H	-150 ± 60	PΔ	
R	R2H	-220 ± 60	RΔ	
S	S2H	-330 ± 60	SΔ	
T	T2H	-470 ± 60	TΔ	
U	U2J	-750 ± 120	UΔ	
L	S2L	+350 ~ -1000	SL	

※ Temperature Characteristics

Temperature Characteristics	below 2.0pF	2.2 ~ 3.9pF	above 4.0pF	above 10pF	
CΔ	C0G	C0G	C0G	C0G	
PΔ	-	P2J	P2H	P2H	
RΔ	-	R2J	R2H	R2H	☞ K : ±250 PPM/°C
SΔ	-	S2J	S2H	S2H	J : ±120 PPM/°C
TΔ	-	T2J	T2H	T2H	H : ±60 PPM/°C
UΔ	-	U2J	U2J	U2J	G : ±30 PPM/°C

► CLASS II (High Dielectric Constant)

Symbol	EIA Code	Capacitance Change (ΔC : %)	Operation Temperature Range
A	X5R	± 15	-55 ~ +85°C
B	X7R	± 15	-55 ~ +125°C
F	Y5V	+22 ~ -82	-30 ~ +85°C

Multilayer Ceramic Capacitor

④ NOMINAL CAPACITANCE

The nominal capacitance value is expressed in pico-Farad(pF) and identified by three-digit number, first two digits represent significant figures and last digit specifies the number of zeros to follow. For values below 1pF, the letter "R" is used as the decimal point and the last digit becomes significant.

example)

100	:	10	×	10 ⁰	=	10pF
102	:	10	×	10 ²	=	1000pF
020	:	2	×	10 ⁰	=	2pF
1R5	:	1.5				pF

⑤ CAPACITANCE TOLERANCE

Temperature Characteristics	Symbol	Tolerance	Applicable Capacitance & Range
C0G(NPO) or T.C Series	B	± 0.1pF	0.5 ~ 3pF
	C	± 0.25pF	0.5 ~ 10pF
	D	± 0.5pF	
	F	± 1pF	6 ~ 10pF
	G	± 2%	E-24 Series for over 10pF
	J	± 5%	
	K	± 10%	
A(X5R) B(X7R)	J	± 5%	E-12 Series
	K	± 10%	
	M	± 20%	
F(Y5V)	Z	-20% ~ +80%	E-6 Series

※ Please consult us for special tolerances.

⑥ RATED VOLTAGE

Symbol	Rated Voltage(Vdc)	Symbol	Rated Voltage(Vdc)
Q	6.3V	D	200V
P	10V	G	500V
O	16V	I	1000V
A	25V	J	2000V
B	50V	K	3000V
C	100V		

Multilayer Ceramic Capacitor

⑦ THICKNESS OPTION

Symbol	Description of the Code
N	Standard thickness (please refer to standard thickness table on next page)
A	Thinner than standard thickness
B	Thicker than standard thickness
C	Standard Thickness High Q (Low ` D.F `)
D	Sn-100% (High-Q)
E	Sn-100% (General)

※ Please Consult us for other termination type.

⑧ PACKAGING TYPE

Symbol	Packaging	Symbol	Packaging
B	Bulk	F	Embossed Tape, 13" Reel
P	Cassette	L	Paper 13" Reel
C	Paper Tape, 7" Reel	O	Paper 10" Reel
D	Paper Tape, 13" Reel	S	Embossed Tape, 10" Reel
E	Embossed Tape, 7" Reel		

► STANDARD CAPACITANCE STEP

Series	Capacitance Step											
E- 3	1.0				2.2				4.7			
E- 6	1.0		1.5		2.2		3.3		4.7		6.8	
E-12	1.0	1.2	1.5	1.8	2.2	2.7	3.3	3.9	4.7	5.6	6.8	8.2
E-24	1.0	1.2	1.5	1.8	2.2	2.7	3.3	3.9	4.7	5.6	6.8	8.2
	1.1	1.3	1.6	2.0	2.4	3.0	3.6	4.3	5.1	6.2	7.5	9.1

※ Standard Capacitance is " Each step $\times 10^n$ "

Multilayer Ceramic Capacitor

■ NEW PART NUMBERING

CL	10	C	101	J	B	8	N	N	N	C
①	②	③	④	⑤	⑥	⑦	⑧	⑨	⑩	⑪

- ① SAMSUNG Multilayer Ceramic Capacitor
- ② Size(mm)
- ③ Capacitance Temperature Characteristic
- ④ Nominal Capacitance
- ⑤ Capacitance Tolerance
- ⑥ Rated Voltage
- ⑦ Thickness Option
- ⑧ Product & Plating Method
- ⑨ Samsung Control Code
- ⑩ Reserved For Future Use
- ⑪ Packaging Type

① PRODUCT ABBREVIATION

Symbol	Product Abbreviation
CL	SAMSUNG Multilayer Ceramic Capacitor

② SIZE(mm)

Symbol	Size(mm)	
	Length	Width
03	0.6	0.3
05	1.0	0.5
10	1.6	0.8
21	2.0	1.2
31	3.2	1.6
32	3.2	2.5
43	4.5	3.2
55	5.7	5.0

Multilayer Ceramic Capacitor

③ CAPACITANCE TEMPERATURE CHARACTERISTIC

Symbol	Temperature Characteristics				Temperature Range
C	Class I	COG	C△	$0 \pm 30(\text{ppm}/^{\circ}\text{C})$	$-55 \sim +125^{\circ}\text{C}$
P		P2H	P△	-150 ± 60	
R		R2H	R△	-220 ± 60	
S		S2H	S△	-330 ± 60	
T		T2H	T△	-470 ± 60	
U		U2J	U△	-750 ± 60	
L		S2L	S△	$+350 \sim -1000$	
A	Class II	X5R	X5R	$\pm 15\%$	$-55 \sim +85^{\circ}\text{C}$
B		X7R	X7R	$\pm 15\%$	$-55 \sim +125^{\circ}\text{C}$
F		Y5V	Y5V	$+22 \sim -82\%$	$-30 \sim +85^{\circ}\text{C}$

※ Temperature Characteristic

Temperature Characteristics	Below 2.0pF	2.2 ~ 3.9pF	Above 4.0pF	Above 10pF
C△	COG	COG	COG	COG
P△	-	P2J	P2H	P2H
R△	-	R2J	R2H	R2H
S△	-	S2J	S2H	S2H
T△	-	T2J	T2H	T2H
U△	-	U2J	U2J	U2J

J : $\pm 120\text{PPM}/^{\circ}\text{C}$, H : $\pm 60\text{PPM}/^{\circ}\text{C}$, G : $\pm 30\text{PPM}/^{\circ}\text{C}$

④ NOMINAL CAPACITANCE

Nominal capacitance is identified by 3 digits.

The first and second digits identify the first and second significant figures of the capacitance.

The third digit identifies the multiplier. 'R' identifies a decimal point.

● Example

Symbol	Nominal Capacitance
1R5	1.5pF
103	10,000pF, 10nF, 0.01 μF
104	100,000pF, 100nF, 0.1 μF

Multilayer Ceramic Capacitor

⑤ CAPACITANCE TOLERANCE

Symbol	Tolerance	Nominal Capacitance
A	$\pm 0.05\text{pF}$	Less than 10pF (Including 10pF)
B	$\pm 0.1\text{pF}$	
C	$\pm 0.25\text{pF}$	
D	$\pm 0.5\text{pF}$	
F	$\pm 1\text{pF}$	
F	$\pm 1\%$	More than 10pF
G	$\pm 2\%$	
J	$\pm 5\%$	
K	$\pm 10\%$	
M	$\pm 20\%$	
Z	+80, -20%	

⑥ RATED VOLTAGE

Symbol	Rated Voltage	Symbol	Rated Voltage
Q	6.3V	E	250V
P	10V	G	500V
O	16V	H	630V
A	25V	I	1,000V
B	50V	J	2,000V
C	100V	K	3,000V
D	200V		

Multilayer Ceramic Capacitor

⑦ THICKNESS OPTION

Type	Symbol	Thickness(T)	Spec
0603	3	0.30	±0.03
1005	5	0.50	±0.05
1608	8	0.80	±0.10
2012	A	0.65	±0.10
	C	0.85	
	F	1.25	±0.10
3216	C	0.85	±0.15
	F	1.25	±0.15
	H	1.6	±0.20
3225	F	1.25	±0.20
	H	1.6	
	I	2.0	
	J	2.5	
4532	F	1.25	±0.20
	H	1.6	
	I	2.0	
	J	2.5	
	L	3.2	±0.30
5750	F	1.25	±0.20
	H	1.6	
	I	2.0	
	J	2.5	
	L	3.2	±0.30

Multilayer Ceramic Capacitor

⑧ PRODUCT & PLATING METHOD

Symbol	Electrode	Termination	Plating Type
A	Pd	Ag	Sn_100%
N	Ni	Cu	Sn_100%
G	Cu	Cu	Sn_100%

⑨ SAMSUNG CONTROL CODE

Symbol	Description of the code	Symbol	Description of the code
A	Array (2-element)	N	Normal
B	Array (4-element)	P	Automotive
C	High - Q	W	3 Terminal EMI Filter
L	LICC		

⑩ RESERVED FOR FUTURE USE

Symbol	Description of the code
N	Reserved for future use

⑪ PACKAGING TYPE

Symbol	Packaging Type	Symbol	Packaging Type
B	Bulk	F	Embossing 13" (10,000EA)
P	Bulk Case	L	Paper 13" (15,000EA)
C	Paper 7"	O	Paper 10"
D	Paper 13" (10,000EA)	S	Embossing 10"
E	Embossing 7"		

Multilayer Ceramic Capacitor

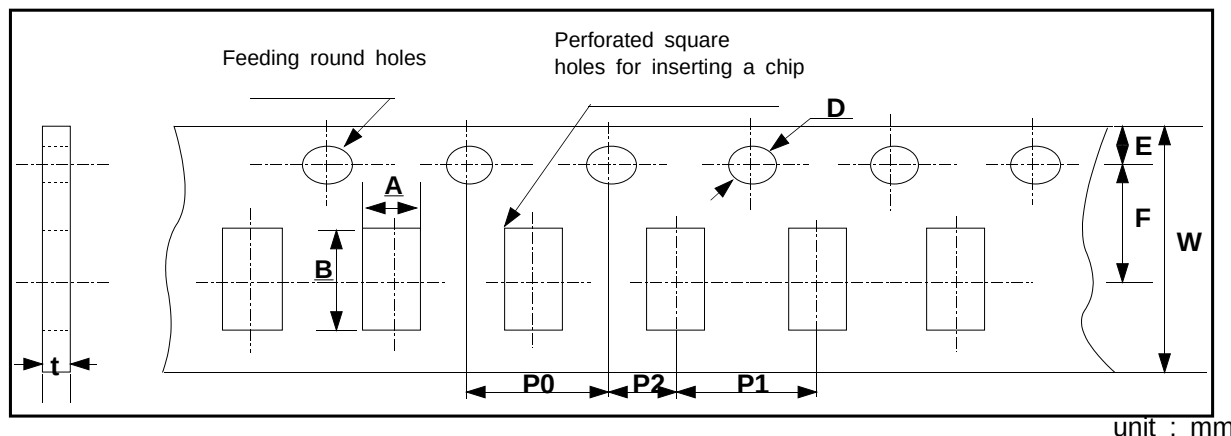
► CAPACITANCE vs CHIP THICKNESS STANDARD

Description		0603 (0201)	1005 (0402)	1608 (0603)	2012 Type (0805)			3216 Type (1206)			3225 Type (1210)				4532 Type (1812)				5750 Type (2220)			
Dimension (mm)	L	0.6 ±0.03	1.0 ±0.05	1.6 ±0.1	2.0±0.1			3.2±0.15		3.2 ±0.2	3.2±0.3				4.5±0.4				5.7±0.4			
	W	0.3 ±0.03	0.5 ±0.05	0.8 ±0.1	1.25±0.1			1.6±0.15		1.6 ±0.2	2.5±0.2				3.2±0.3				5.0±0.4			
	T	0.3 ±0.03	0.5~ ±0.05	0.8 ±0.1	0.65 ±0.1	0.85 ±0.1	1.25 ±0.1	0.85 ±0.15	1.25 ±0.15	1.6 ±0.2	1.25 ±0.2	1.6 ±0.2	2.0 ±0.2	2.5 ±0.2	1.25 ±0.2	1.6 ±0.2	2.0 ±0.2	2.5 ±0.2	1.6 ±0.2	2.0 ±0.2	2.5 ±0.2	
CAPACITANCE (pF)	SL	50V	-	0.5~ 240	0.5 ~ 1000	0.5 ~ 1500	1600~ 2700	0.5 ~ 2700	3000~ 5600	6200~ 8200	-	-	-	-	-	-	-	-	-	-	-	
	C, TC (Except SL,UJ)	25V	0.5~ 47	0.5~ 220	0.5 ~ 1000	-	-	3300~ 8200	1500~ 3600	3900~ 6800	7500~ 10000	-	-	-	-	-	100000	-	-	-	-	
		50V	-	0.5 ~ 180	0.5 ~ 1000	0.5 ~ 560	620~ 1000	1100~ 3300	0.5 ~ 2200	2400~ 4700	-	560~ 10000	11000~ 22000	24000~ 47000	-	1000~ 13000	15000~ 22000	24000~ 47000	62000~ 68000	43000	93000	130000
CAPACITANCE RANGE (nF)	A (X5R)	6.3V	10	220	2200	-	-	10000	-	-	10000	-	-	-	22000	-	-	-	47000	-	-	47000
		10V	10	100	1000	-	-	2200	-	-	4700~ 10000	-	-	-	22000	-	-	-	-	-	-	47000
		16V	-	47	330~ 470	-	-	1000	-	-	4700	-	-	-	6800~ 10000	-	-	-	-	-	-	-
		25V	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	
		50V	-	6.8~ 10	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	
	B (X7R)	6.3V	0.1~ 10	47~ 100	470~ 1000	-	-	1000	-	-	6800~ 10000	-	-	-	22000	-	-	-	-	-	-	-
		10V	0.1~ 10	33~ 100	220~ 470	220~ 270	330~ 470	560~ 1000	-	1000~ 3300	4700	1500~ 2200	3300	3900~ 4700	-	-	-	-	22000	-	-	-
		16V	0.1~ 1	10~ 33	100~ 220	68~ 200	220~ 330	390~ 1000	330~ 680	1000~ 1500	2200~ 3300	1500~ 2200	3300	3900~ 4700	-	-	-	2200	-	-	-	
		25V	-	4.7~ 10	47~ 100	39~ 68	82~ 100	150~ 470	100~ 330	470~ 620	680~ 1000	680~ 1500	1800	2200	-	-	-	1000	-	-	-	10000
		50V	-	0.22~ 4.7	0.22~ 100	0.22~ 39	47~ 100	220	1~ 150	220	390~ 1000	2.2~ 680	820~ 1000	-	-	10~ 1000	-	-	-	-	-	3300~ 4700
	F (Y5V)	6.3V	10~ 100	-	2200	-	-	10000	-	-	-	-	-	47000	-	-	-	-	-	-	-	-
		10V	-	220~ 330	100~ 1000	-	-	4700	-	4700	10000~ 22000	-	-	-	22000	-	-	-	-	-	-	100000
		16V	-	10~ 220	100~ 1000	10~ 680	820~ 1000	1200~ 2200	1000~ 2200	2700~ 4700	10000	3300~ 6800	10000	15000	-	-	-	22000	-	-	-	-
		25V	-	10~ 33	22~ 330	10~ 220	270~ 470	560~ 1000	470~ 1000	1200~ 2200	2700~ 3300	1000~ 3300	4700~ 10000	-	-	-	-	-	10000	-	-	-
		50V	-	2.2~ 10	2.2~ 100	2.2~ 68	82~ 150	180~ 1000	10~ 470	560~ 1000	-	100~ 1000	-	-	-	-	-	-	10000	-	-	-

Multilayer Ceramic Capacitor

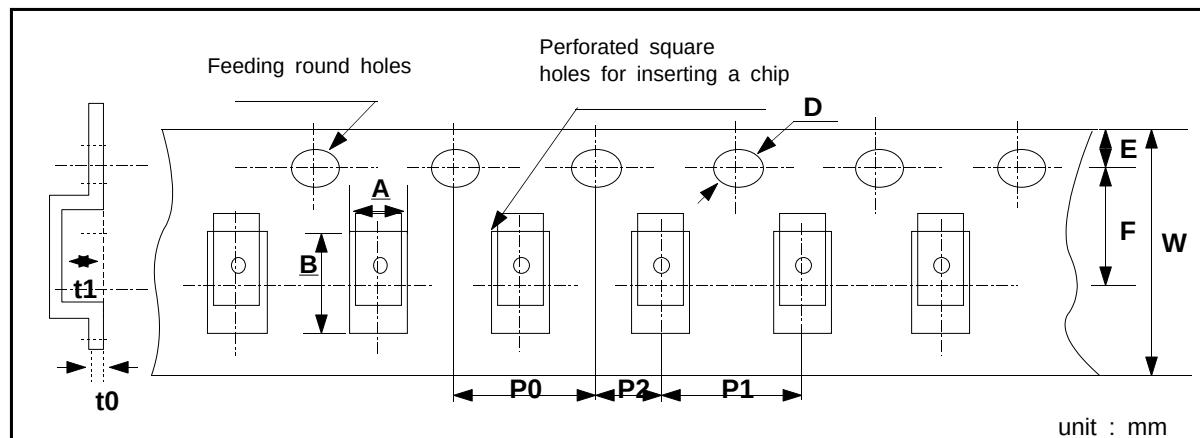
PACKAGING

CARDBOARD PAPER TAPE



Symbol	Type	W	F	E	P1	P2	P0	D	t	A	B
Dimension	03				2.0 ±0.05				0.37 ±0.03	0.38 ±0.03	0.68 ±0.03
	05								0.6 ±0.05	0.65 +0.05/-0.1	1.15 +0.05/-0.1
	10	8.0 ±0.3	3.5 ±0.05	1.75 ±0.1		2.0 ±0.05	4.0 ±0.1	Φ1.5 +0.1/-0	1.1 MAX	1.1 ±0.2	1.9 ±0.2
	21				4.0 ±0.1					1.6 ±0.2	2.4 ±0.2
	31									2.0 ±0.2	3.6 ±0.2

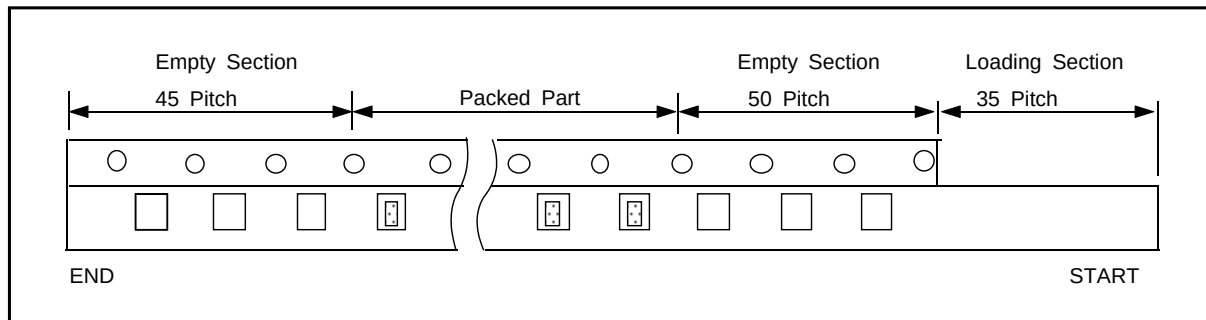
EMBOSSED PLASTIC TAPE



Symbol	Type	W	F	E	P1	P2	P0	D	t0	t1	A	B
Dimension	21										1.45 ±0.2	2.3 ±0.2
	31										2.0 ±0.2	3.6 ±0.2
	32	8.0 ±0.3	3.5 ±0.05	1.75 ±0.1	4.0 ±0.1	2.0 ±0.05	4.0 ±0.1	Φ1.5 +0.1/-0	0.6 max	2.5 max	2.9 ±0.2	3.6 ±0.2
	43										3.6 ±0.2	4.9 ±0.2
	55										5.4 ±0.2	6.0 ±0.2

Multilayer Ceramic Capacitor

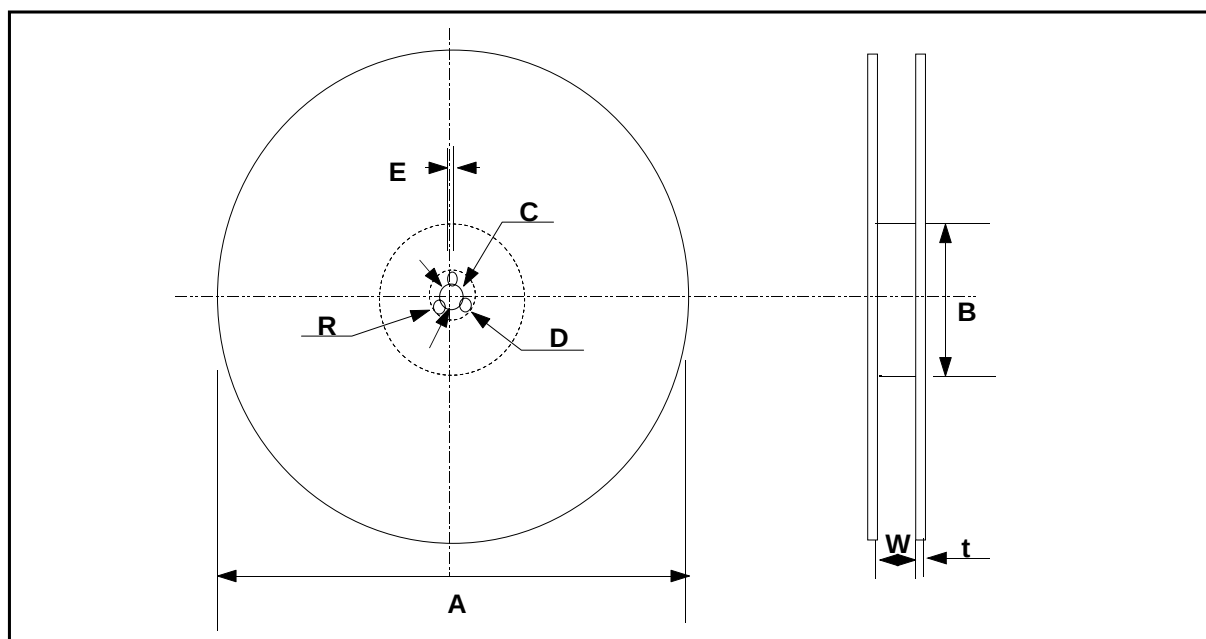
● TAPING SIZE



unit : pcs

Symbol	Cardboard Paper Tape	Embossed Plastic Tape
7" Reel	4000	2000
13" Reel	15000	-

● REEL DIMENSION



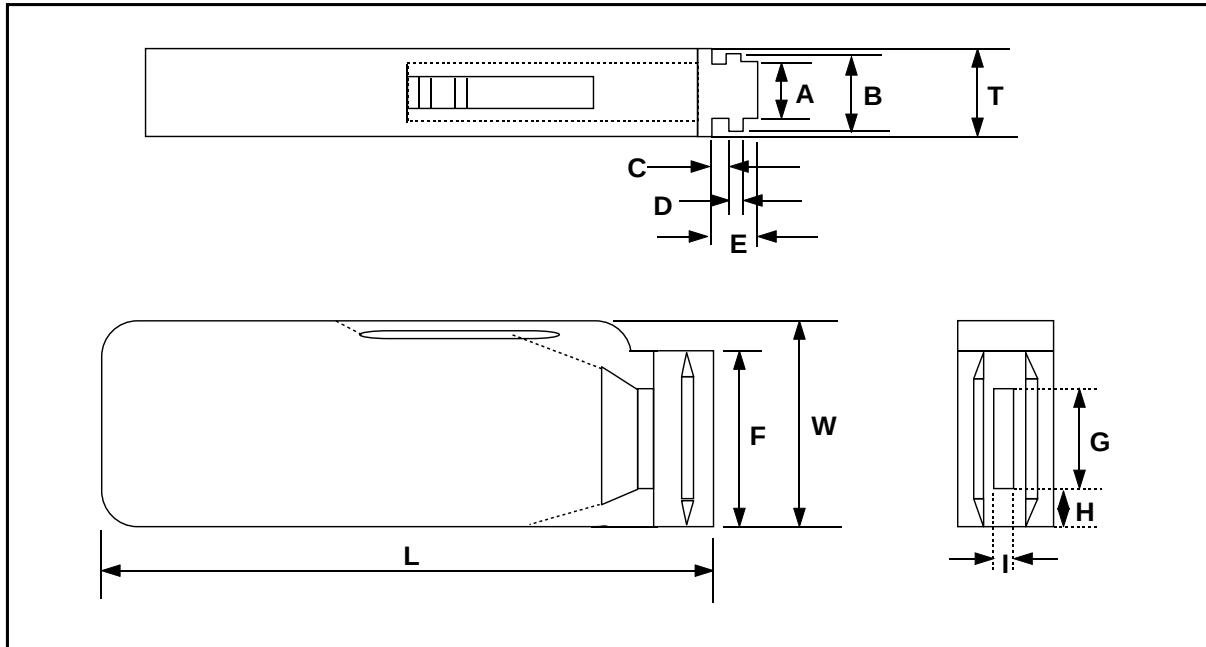
unit : mm

Symbol	A	B	C	D	E	W	t	R
7" Reel	$\phi 178 \pm 2.0$	min. $\phi 50$	$\phi 13 \pm 0.5$	21 ± 0.8	2.0 ± 0.5	10 ± 1.5	0.8 ± 0.2	1.0
13" Reel	$\phi 330 \pm 2.0$	min. $\phi 70$						

Multilayer Ceramic Capacitor

● BULK CASE PACKAGING

- Bulk case packaging can reduce the stock space and transportation costs.
- The bulk feeding system can increase the productivity.
- It can eliminate the components loss.



Symbol	A	B	T	C	D	E
Dimension	6.8 ± 0.1	8.8 ± 0.1	12 ± 0.1	$1.5 + 0.1/-0$	$2 + 0/-0.1$	4.7 ± 0.1

Symbol	F	W	G	H	L	I
Dimension	$31.5 + 0.2/-0$	$36 + 0/-0.2$	19 ± 0.35	7 ± 0.35	110 ± 0.7	5 ± 0.35

● QUANTITY

Size	05(0402)	10(0603)	21(0805)	
			$T \leq 0.85\text{mm}$	$T \geq 1.0\text{mm}$
Quantity	50,000	10,000~15,000*	10,000	5,000

* Option

Multilayer Ceramic Capacitor

■ CHARACTERISTIC MAP

● CLASS I

Temperature Characteristics	Size	Voltage	Capacitance Range (pF)									
			0.5	10	100	1000	10000	100000	1000000	10000000	100000000	
SL,UJ	05 (0402)	50V				240						
	10 (0603)	50V				1000						
	21 (0805)	50V				2700						
	31 (1206)	50V				8200						
C(COG) & TC Series	03 (0201)	25V			47							
	05 (0402)	25V			220							
		50V			180							
	10 (0603)	25V			1000							
		50V			1000							
	21 (0805)	25V				3300	8200					
		50V				3300						
	31 (1206)	25V				1500	10000					
		50V				4700						
	32 (1210)	50V			560	47000						
		100V				4700	18000					
	43 (1812)	25V						100000				
		50V				1000	68000					
	55 (2220)	50V				43000	130000					

Multilayer Ceramic Capacitor

● CLASS II , A(X5R)

Temperature Characteristics	Size	Voltage	Capacitance Range (pF)							
			10	100	1000	10000	100000	1000000	10000000	100000000
A(X5R)	0603 (0201)	6.3V				■ 10000				
		10V				■ 10000				
	1005 (0402)	6.3V					■ 220000			
		10V					■ 100000			
		16V				■ 47000				
		50V			6800	■ 10000				
	1608 (0603)	6.3V						■ 2200000		
		10V						■ 1000000		
		16V				330000	■ 470000			
	2012 (0805)	6.3V							■ 10000000	
		10V						■ 2200000		
		16V						■ 1000000		
	3216 (1206)	6.3V							■ 10000000	
		10V					4700000	■ 10000000		
		16V						■ 4700000		
	3225 (1210)	6.3V							■ 22000000	
		10V							■ 22000000	
		16V					6800000	■ 10000000		
	4532 (1812)	6.3V							■ 47000000	
	5750 (2220)	6.3V							■ 47000000	
		10V							■ 47000000	

Multilayer Ceramic Capacitor

● CLASS II , B(X7R)

Temperature Characteristics	Size	Voltage	Capacitance Range (pF)							
			10	100	1000	10000	100000	1000000	10000000	100000000
B(X7R)	03 (0201)	6.3V		100		10000				
		10V		100		10000				
		16V		100	1000					
	05 (0402)	6.3V				47000	100000			
		10V				33000	100000			
		16V			10000	33000				
		25V			4700	10000				
		50V		220	4700					
	10 (0603)	6.3V					470000	1000000		
		10V					220000	470000		
		16V					100000	220000		
		25V				47000	100000			
		50V		220			100000			
	21 (0805)	6.3V						1000000		
		10V					220000	1000000		
		16V					68000	1000000		
		25V				39000	470000			
		50V		220			220000			
	31 (1206)	6.3V						6800000	10000000	
		10V					1000000	4700000		
		16V					330000	3300000		
		25V				100000	1000000			
		50V			1000			1000000		

Multilayer Ceramic Capacitor

● CLASS II , B(X7R)

Temperature Characteristics	Size	Voltage	Capacitance Range (pF)									
			10	100	1000	10000	100000	1000000	10000000	100000000		
B(X7R)	32 (1210)	6.3V								■ 22000000		
		10V						1500000	■ 4700000			
		16V						1500000	■ 4700000			
		25V					680000	■ 2200000				
		50V			2200	■	1000000					
	43 (1812)	10V							■ 22000000			
		16V						■ 2200000				
		25V						■ 1000000				
		50V			10000	■	1000000					
	55 (2220)	25V							■ 10000000			
		50V						3300000	■ 4700000			

Multilayer Ceramic Capacitor

● CLASS II , F(Y5V)

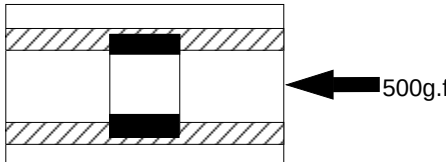
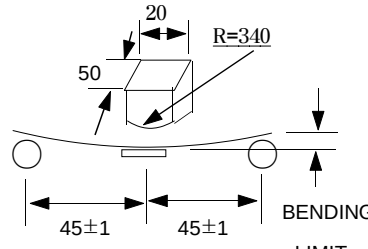
Temperature Characteristics	Size	Voltage	Capacitance Range (pF)							
			10	100	1000	10000	100000	1000000	10000000	100000000
F(Y5V)	03 (0201)	6.3V				10000	100000			
	05 (0402)	10 V					220000	330000		
		16 V				10000	220000			
		25 V				10000	33000			
		50 V			2200	10000				
	10 (0603)	6.3V						2200000		
		10 V				100000	1000000			
		16 V				100000	1000000			
		25 V				22000	330000			
		50 V			2200	100000				
	21 (0805)	6.3V						10000000		
		10 V						4700000		
		16 V				10000	2200000			
		25 V				10000	1000000			
		50 V			2200	1000000				
	31 (1206)	10 V					4700000	22000000		
		16 V					1000000	10000000		
		25 V					470000	3300000		
		50 V				10000	1000000			
	32 (1210)	6.3V						47000000		
		10 V						22000000		
		16 V					3300000	15000000		
		25 V					1000000	10000000		
		50 V				100000	1000000			
	43 (1812)	16V						22000000		
		25 V						10000000		
		50 V						10000000		
	55 (2220)	10 V							100000000	

Multilayer Ceramic Capacitor

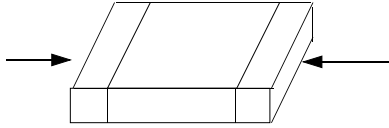
RELIABILITY TEST DATA

NO	ITEM		PERFORMANCE	TEST CONDITION																																																														
1	APPEARANCE		NO ABNORMAL EXTERIOR APPEARANCE	THROUGH MICROSCOPE(×10)																																																														
2	INSULATION RESISTANCE		10,000MΩ OR 500MΩ·μF PRODUCT WHICHEVER IS SMALLER (RATED VOLTAGE IS BELOW 16V : 10,000MΩ OR 100MΩ·μF)	RATED VOLTAGE SHALL BE APPLIED. MEASUREMENT TIME IS 60 ~ 120 RATED VOLTAGE TIME 60 SEC.																																																														
3	WITHSTANDING VOLTAGE		NO DIELECTRIC BREAKDOWN OR MECHANICAL BREAKDOWN	CLASSⅠ : 300% OF THE RATED VOLTAGE FOR 1~5 SEC, CLASSⅡ :250% OF THE RATED VOLTAGE FOR 1~5 SEC IS APPLIED WITH LESS THAN 50mA CURRENT																																																														
4	CAPACITANCE	CLASSⅠ	WITHIN THE SPECIFIED TOLERANCE	CAPACITANCE	FREQUENCY	VOLTAGE																																																												
				1,000pF AND BELOW	1MHz±10%	0.5 ~ 5 Vrms																																																												
				MORE THAN 1,000pF	1kHz±10%																																																													
		CLASSⅡ	WITHIN THE SPECIFIED TOLERANCE	CAPACITANCE	FREQUENCY	VOLTAGE																																																												
				10μF AND BELOW	1kHz±10%	1.0±0.2Vrms																																																												
				MORE THAN 10μF	120Hz±20%	0.5±0.1Vrms																																																												
5	Q	CLASSⅠ	OVER 30pF : Q ≥1,000 LESS THAN 30pF: Q ≥400 +20C (C : CAPACITANCE)	CAPACITANCE	FREQUENCY	VOLTAGE																																																												
				1,000pF AND BELOW	1MHz±10%	0.5 ~ 5 Vrms																																																												
				MORE THAN 1,000pF	1kHz±10%																																																													
6	Tanδ	CLASSⅡ	1. CHAR : B <table><tr><td>RATED VOLTAGE</td><td>DF SPEC</td></tr><tr><td>6.3V</td><td>0.05 max</td></tr><tr><td>10V</td><td>0.05 max</td></tr><tr><td>16V</td><td>0.035 max</td></tr><tr><td>25V</td><td>0.025 max</td></tr><tr><td>50V 이상</td><td>0.025 max</td></tr></table> 2. CHAR : F <table><tr><td></td><td>6.3V</td><td>10V</td><td>16V</td><td>25V</td><td>50V</td></tr><tr><td>1005</td><td>-</td><td>0.125max</td><td>0.09max (C < 220nF) 0.125max (C ≥ 220nF)</td><td>0.05max</td><td>0.05max</td></tr><tr><td>1608</td><td>0.16max</td><td>0.125max</td><td>0.09max</td><td>0.05max(C ≤ 100nF) 0.07max(C > 100nF)</td><td>0.05max</td></tr><tr><td>2012</td><td>0.16max</td><td>0.125max</td><td>0.09max</td><td>0.07max</td><td>0.05max</td></tr><tr><td>3216</td><td>0.16max</td><td>0.125max</td><td>0.09max</td><td>0.07max</td><td>0.05max</td></tr><tr><td>3225</td><td>0.16max</td><td>0.125max</td><td>0.09max</td><td>0.07max(C ≤ 6.8μF) 0.09max(C > 6.8μF)</td><td>0.05max</td></tr><tr><td>4532</td><td>0.16max</td><td>0.16max</td><td>0.09max</td><td>-</td><td>-</td></tr><tr><td>5750</td><td></td><td>0.125max</td><td>-</td><td>-</td><td>-</td></tr></table>	RATED VOLTAGE	DF SPEC	6.3V	0.05 max	10V	0.05 max	16V	0.035 max	25V	0.025 max	50V 이상	0.025 max		6.3V	10V	16V	25V	50V	1005	-	0.125max	0.09max (C < 220nF) 0.125max (C ≥ 220nF)	0.05max	0.05max	1608	0.16max	0.125max	0.09max	0.05max(C ≤ 100nF) 0.07max(C > 100nF)	0.05max	2012	0.16max	0.125max	0.09max	0.07max	0.05max	3216	0.16max	0.125max	0.09max	0.07max	0.05max	3225	0.16max	0.125max	0.09max	0.07max(C ≤ 6.8μF) 0.09max(C > 6.8μF)	0.05max	4532	0.16max	0.16max	0.09max	-	-	5750		0.125max	-	-	-	CAPACITANCE	FREQUENCY	VOLTAGE
				RATED VOLTAGE	DF SPEC																																																													
				6.3V	0.05 max																																																													
				10V	0.05 max																																																													
				16V	0.035 max																																																													
				25V	0.025 max																																																													
				50V 이상	0.025 max																																																													
					6.3V	10V	16V	25V	50V																																																									
				1005	-	0.125max	0.09max (C < 220nF) 0.125max (C ≥ 220nF)	0.05max	0.05max																																																									
				1608	0.16max	0.125max	0.09max	0.05max(C ≤ 100nF) 0.07max(C > 100nF)	0.05max																																																									
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				4532	0.16max	0.16max	0.09max	-	-																																																									
				5750		0.125max	-	-	-																																																									
10μF AND BELOW	1kHz±10%	1.0±0.2Vrms																																																																
MORE THAN 10μF	120Hz±20%	0.5±0.1Vrms																																																																

Multilayer Ceramic Capacitor

NO	ITEM		PERFORMANCE		TEST CONDITION												
7	CAPACITANCE TEMPERATURE COEFFICIENT	CLASS I	CHARACTERISTIC	TEMP. COEFFICIENT (PPM/℃)	THESE SYMMETRICAL TOLERANCE APPLY TO 2 POINT MEASUREMENT OF TEMPERATURE COEFFICIENT: ONE AT 25℃ AND AT 85℃ <table><tr><th>STEP</th><th>TEMPERATURE</th></tr><tr><td>1</td><td>25 ± 2</td></tr><tr><td>2</td><td>MIN RATED TEMP ± 2</td></tr><tr><td>3</td><td>25 ± 2</td></tr><tr><td>4</td><td>MAX RATED TEMP ± 2</td></tr><tr><td>5</td><td>25 ± 2</td></tr></table>	STEP	TEMPERATURE	1	25 ± 2	2	MIN RATED TEMP ± 2	3	25 ± 2	4	MAX RATED TEMP ± 2	5	25 ± 2
			STEP	TEMPERATURE													
			1	25 ± 2													
			2	MIN RATED TEMP ± 2													
			3	25 ± 2													
			4	MAX RATED TEMP ± 2													
			5	25 ± 2													
			C0G	0 ± 30													
			PH	-150 ± 60													
RH	-220 ± 60																
SH	-330 ± 60																
TH	-470 ± 60																
UL	-750 ± 120																
SL	+350 ~ -1000																
8	TEMPERATURE CHARACTERISTIC S	CLASS II	CAPACITANCE CHANGE		The change of capacitance should be got from the capacitance at 25℃. After capacitance measured from Min. Temp. to Max. Temp., it should be calculated from the formula below. $\frac{C2 - C1}{C1} \times 100 \%$ C1 : CAPACITANCE AT STANDARD TEMPERATURE(25℃) C2 : CAPACITANCE AT EACH TEMPERATURE												
			CHAR.	CAP. CHANGE(%)													
			A,B	±15%													
			F	+22% ~ -82%													
9	ADHESIVE STRENGTH OF TERMINATION	NO INDICATION OF PEELING SHALL OCCUR ON THE TERMINAL ELECTRODE.		A 500g.f PRESSURE SHALL BE APPLIED FOR 10±1 SECOND.  SEE (FIG.1)													
10	BENDING STRENGTH	APPEARANCE	NO MECHANICAL DAMAGE SHALL OCCUR.		BENDING SHALL BE APPLIED TO THE LIMIT(1mm) WITH 0.3mm/SEC. KEEP THE TEST BOARD AT THE LIMIT POINT IN 5 SEC., THEN MEASURE CAPACITANCE. <table><tr><th>CHARACTER</th><th>LIMIT</th></tr><tr><td>C, A, B, F</td><td>1mm</td></tr></table>  SEE (FIG.2)	CHARACTER	LIMIT	C, A, B, F	1mm								
		CHARACTER	LIMIT														
		C, A, B, F	1mm														
		CAPACITANCE	CHARACTER	CHANGE OF CAPACITANCE													
			CLASS I	WITHIN ±5% OR ± 0.5 pF WHICHEVER IS LARGER													
				A,B		WITHIN ±12.5%											
CLASS II	F		WITHIN ±30%														

Multilayer Ceramic Capacitor

NO	ITEM			PERFORMANCE		TEST CONDITION											
11	SOLDERABILITY			MORE THAN 75% OF THE TERMINAL SURFACE IS TO BE SOLDERED NEWLY, SO METAL PART DOES NOT COME OUT OR DISSOLVE  IN PB--FREE PART, MORE THAN 95% OF THE TERMINAL SURFACE IS TO BE SOLDERED NEWLY		SOLDER TEMPERATURE : 230±5℃ DIP TIME : 3±1 Sec SOLDER : H63A FLUX : RMA TYPE *PB-FREE SOLDER TEMPERATURE : 260±5℃ SOLDER : Sn96.5-3Ag-0.5Cu Flux : RMA TYPE DIP TIME : 3±0.1Sec * PRE-HEATING : AT 80~120℃ FOR 10~30SEC.											
12	RESISTANCE TO SOLDERING HEAT	APPEARANCE	NO MECHANICAL DAMAGE SHALL OCCUR			DIP : SOLDER TEMPERATURE OF 270±5℃ DIP TIME :10±1 SEC. EACH TERMINATION SHALL BE FULLY IMMERSED AND PREHEATED AS FOLLOWING: <table><tr><th>STEP</th><th>TEMP.(℃)</th><th>TIME (SEC.)</th></tr><tr><td>1</td><td>80~100</td><td>60</td></tr><tr><td>2</td><td>150~180</td><td>60</td></tr></table> MEASURE AT ROOM TEMP. AFTER COOLING FOR CLASS I : 24 ± 2 HOURS CLASS II : 48 ± 4 HOURS			STEP	TEMP.(℃)	TIME (SEC.)	1	80~100	60	2	150~180	60
		STEP	TEMP.(℃)	TIME (SEC.)													
		1	80~100	60													
		2	150~180	60													
		CAPACITANCE	CHARACTERISTIC	CAP. CHANGE													
			CLASS I	WITHIN ±2.5% OR ±0.25pF WHICHEVER IS LARGER													
				CLASS II	A,B				WITHIN ±7.5%								
			F	WITHIN ±20%													
		Q CLASS I	30pF AND OVER : Q≥ 1000 LESS THAN 30pF : Q≥ 400+20×C														
Tanδ CLASS II	TO SATISFY THE SPECIFIED INITIAL VALUE																
INSULATION RESISTANCE	TO SATISFY THE SPECIFIED INITIAL VALUE																
WITHSTANDING VOLTAGE	TO SATISFY THE SPECIFIED INITIAL VALUE																
13	VIBRATION TEST	APPEARANCE	NO MECHANICAL DAMAGE SHALL OCCUR.			BENDING SHALL BE APPLIED TO THE LIMIT(1mm) WITH 0.3mm/SEC. KEEP THE TEST BOARD AT THE LIMIT POINT IN 5 SEC., THEN MEASURE CAPACITANCE. <table><tr><th>CHAR.</th><th>FREQUENCY RANGE</th></tr><tr><td>A,B,C,F</td><td>10Hz → 55Hz → 10Hz</td></tr></table> <table><tr><th>CHAR.</th><th>TRAVERSED TIME</th></tr><tr><td>A,B,C,F</td><td>1 min</td></tr></table> THE ENTIRE FREQUENCY RANGE, FROM 10 TO 55Hz AND RETURN TO 10Hz, SHALL BE TRAVERSED IN 1 MINUTE. THIS CYCLE SHALL BE PERFORMED 2 HOURS IN EACH THERE MUTUALLY PERPENDICULAR DIRECTION, FOR TOTAL PERIOD OF 6 HOURS.			CHAR.	FREQUENCY RANGE	A,B,C,F	10Hz → 55Hz → 10Hz	CHAR.	TRAVERSED TIME	A,B,C,F	1 min	
		CHAR.	FREQUENCY RANGE														
		A,B,C,F	10Hz → 55Hz → 10Hz														
		CHAR.	TRAVERSED TIME														
		A,B,C,F	1 min														
		CAPACITANCE	CHARACTERISTIC	CAP. CHANGE													
			CLASS I	WITHIN ±2.5% OR ±0.25pF WHICHEVER IS LARGER													
				CLASS II	A,B				WITHIN ±5%								
			F	WITHIN ±20%													
Q CLASS I	30pF AND OVER : Q≥ 1000 LESS THAN 30pF : Q≥ 400+20×C																
Tanδ CLASS II	TO SATISFY THE SPECIFIED INITIAL VALUE																
INSULATION RESISTANCE	TO SATISFY THE SPECIFIED INITIAL VALUE																

* THE INITIAL VALUE OF HIGH DIELECTRIC CONSTANT SERIES SHALL BE MEASURED AFTER THE HEAT TREATMENT OF $150 \pm 0/-10^{\circ}\text{C}$, 1hr AND SITTING OF $48\pm 4\text{hr}$ AT ROOM TEMPERATURE & ROOM HUMIDITY.

Multilayer Ceramic Capacitor

NO	ITEM		PERFORMANCE						TEST CONDITION																	
14	HUMIDITY (STEADY STATE)	APPEARANCE	NO MECHANICAL DAMAGE SHALL OCCUR						TEMPERATURE : 40±2 ℃ RELATIVE HUMIDITY:90~95 %RH TEST TIME : 500 +12/-0 Hr. MEASURE AT ROOM TEMPERATURE AFTER COOLING FOR CLASS I : 24±2 Hr. CLASS II : 48±4 Hr.																	
		CAPACITANCE	CHARACTERISTIC		CAPACITANCE CHANGE					CLASS II (A,B)	1005 C ≥0.22μF 1608 C ≥2.2μF 2012 C ≥4.7μF 3216 C ≥10.0μF 3225 C ≥22.0μF 4532 C ≥47.0μF 5750 C ≥100.0μF															
			CLASS I		WITHIN ±5% OR ±0.5pF WHICHEVER IS LARGER																					
			CLASS II	A,B		WITHIN ±12.5%																				
				F		WITHIN ±30%																				
		Q CLASS I	30pF AND OVER : Q≥ 350 10 ~30pF : Q≥ 275 + 2.5×C LESS THAN 10pF : Q≥ 200 + 10×C						6.3V Tanδ		0.125 MAX *Condition															
Tanδ CLASS II	<table><tr><td>CHAR.</td><td>25V AND OVER</td><td>16V</td><td>10V</td><td>6.3V</td><td>4V</td></tr><tr><td>A,B</td><td>0.05</td><td>0.05 MAX</td><td>0.05 MAX</td><td>0.075 MAX</td><td>0.1 MAX</td></tr><tr><td>F</td><td>0.075 MAX</td><td>0.1MAX (C <1.0μF) 0.125 MAX (C ≥1.0μF)</td><td>0.15 MAX</td><td>0.195 MAX</td><td>0.25 MAX</td></tr></table>						CHAR.	25V AND OVER	16V	10V	6.3V	4V	A,B	0.05	0.05 MAX	0.05 MAX	0.075 MAX	0.1 MAX	F	0.075 MAX	0.1MAX (C <1.0μF) 0.125 MAX (C ≥1.0μF)	0.15 MAX	0.195 MAX	0.25 MAX		
CHAR.	25V AND OVER	16V	10V	6.3V	4V																					
A,B	0.05	0.05 MAX	0.05 MAX	0.075 MAX	0.1 MAX																					
F	0.075 MAX	0.1MAX (C <1.0μF) 0.125 MAX (C ≥1.0μF)	0.15 MAX	0.195 MAX	0.25 MAX																					
INSULATION RESISTANCE	MINIMUM INSULATION RESISTANCE: 1,000 MΩ OR 50MΩ·μF PRODUCT WHICHEVER IS SMALLER																									
15	MOISTURE RESISTANCE	APPEARANCE	NO MECHANICAL DAMAGE SHALL OCCUR						APPLIED VOLTAGE : RATED VOLTAGE TEMPERATURE : 40±2 ℃ RELATIVE HUMIDITY:90~95%RH TEST TIME : 500 +12/-0 Hr. CURRENT APPLIED : 50mA MAX. <INITIAL MEASUREMENT> CLASS II SHOULD BE MEASURED INITIAL VALUE AFTER BE HEAT-TREATED FOR 1 HR IN 150℃+0/-10℃ AND BE LEFT FOR 48±4HR AT ROOM TEMPERATURE. <LATTER MEASUREMENT> CLASS I SHOULD BE MEASURED AFTER LEFT FOR 24±2 HRS IN ROOM TEMPERATURE AND HUMIDITY. CLASS II SHOULD BE MEASURED LATTER VALUE AFTER BE HEAT-TREATED FOR 1 HR IN 150℃+0/-10 ℃ AND BE LEFT FOR 48±4HR AT ROOM TEMPERATURE.																	
		CAPACITANCE	CHARACTERISTIC		CAPACITANCE CHANGE					CLASS II (A,B)	1005 C ≥0.22μF 1608 C ≥2.2μF 2012 C ≥4.7μF 3216 C ≥10.0μF 3225 C ≥22.0μF 4532 C ≥47.0μF 5750 C ≥100.0μF															
			CLASS I		WITHIN ±7.5% OR ±0.75pF WHICHEVER IS LARGER																					
			CLASS II	A,B		WITHIN ±12.5%																				
				F	WITHIN ±30%			WITHIN +30~-40%																		
		Q CLASS I	30pF AND OVER : Q≥ 200 30pF AND BELOW : Q≥ 100 + 10/3×C																							
Tanδ CLASS II	<table><tr><td>CHAR.</td><td>25V AND OVER</td><td>16V</td><td>10V</td><td>6.3V</td><td>4V</td></tr><tr><td>A,B</td><td>0.05 MAX</td><td>0.05 MAX</td><td>0.05 MAX</td><td>0.075 MAX</td><td>0.1 MAX</td></tr><tr><td>F</td><td>0.075 MAX</td><td>0.1MAX (C <1.0μF) 0.125MAX (C ≥1.0μF)</td><td>0.15 MAX</td><td>0.195 MAX</td><td>0.25 MAX</td></tr></table>						CHAR.	25V AND OVER	16V	10V	6.3V	4V	A,B	0.05 MAX	0.05 MAX	0.05 MAX	0.075 MAX	0.1 MAX	F	0.075 MAX	0.1MAX (C <1.0μF) 0.125MAX (C ≥1.0μF)	0.15 MAX	0.195 MAX	0.25 MAX		
CHAR.	25V AND OVER	16V	10V	6.3V	4V																					
A,B	0.05 MAX	0.05 MAX	0.05 MAX	0.075 MAX	0.1 MAX																					
F	0.075 MAX	0.1MAX (C <1.0μF) 0.125MAX (C ≥1.0μF)	0.15 MAX	0.195 MAX	0.25 MAX																					
INSULATION RESISTANCE	MINIMUM INSULATION RESISTANCE: 500 MΩ OR 25MΩ·μF PRODUCT, WHICHEVER IS SMALLER.																									

Multilayer Ceramic Capacitor

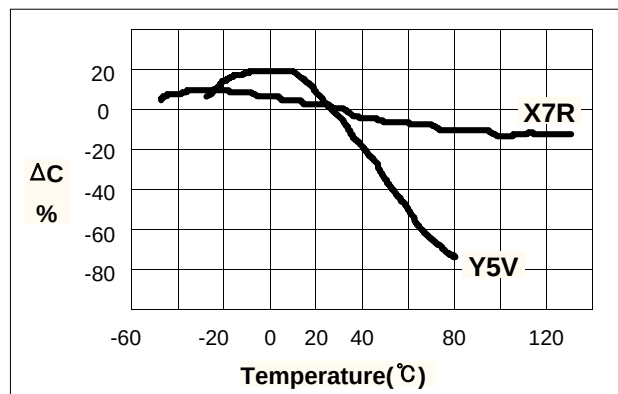
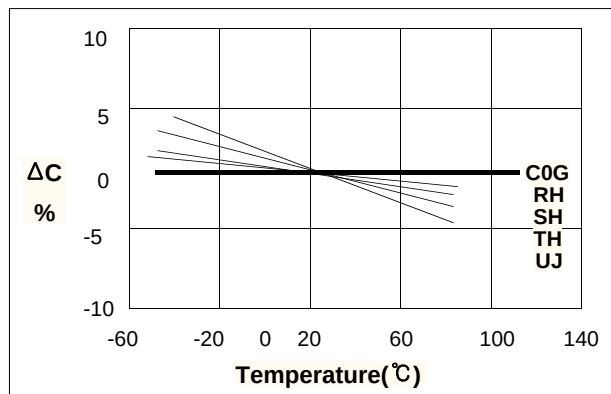
NO	ITEM		PERFORMANCE					TEST CONDITION	
16	HIGH TEMPERATURE RESISTANCE	APPEARANCE	NO MECHANICAL DAMAGE SHALL OCCUR					APPLIED VOLTAGE : 150%, 200% OF RATED VOLTAGE TEST TIME : 1000 +48/-0 Hr. CURRENT APPLIED : 50mA MAX.	
		CAPACITANCE	CHARACTERISTIC		CAP. CHANGE				
			CLASS I		WITHIN ±3% OR ±0.3pF, WHICHEVER IS LARGER				
			CLASS II	A,B	WITHIN ±12.5%				
				F	WITHIN ±30%				
					WITHIN+30~40%				
		1005 C>0.47μF 1608 C>1.0μF 2012 C>4.7μF 3216 C>10.0μF 3225 C>22.0μF 4532 C>47.0μF							
Q CLASS I	30pF AND OVER : Q ≥ 350 10 ~ 30 pF : Q ≥ 275 + 2.5×C LESS THAN 10pF :Q ≥200 + 10×C					<INITIAL MEASUREMENT> CLASS II SHOULD BE MEASURED INITIAL VALUE AFTER BE HEAT-TREATED FOR 1 HR IN 150℃+0/-10℃ AND BE LEFT FOR 48±4HR AT ROOM TEMPERATURE. <LATTER MEASUREMENT> CLASS I SHOULD BE MEASURED AFTER LEFT FOR 24±2 HRS IN ROOM TEMPERATURE AND HUMIDITY. CLASS II SHOULD BE MEASURED LATTER VALUE AFTER BE HEAT-TREATED FOR 1 HR IN 150℃+0/-10℃ AND BE LEFT FOR 48±4HR AT ROOM TEMPERATURE.			
Tanδ CLASS II	CHAR.	25V AND OVER	16V	10V	6.3V			4V	
		A,B	0.05 MAX	0.05 MAX	0.05 MAX	0.075 MAX	0.1 MAX		
		F	0.075 MAX	0.1MAX (C<1.0μF) 0.125MAX (C≥1.0μF)	0.15 MAX	0.195 MAX	0.25 MAX		
		INSULATION RESISTANCE	MINIMUM INSULATION RESISTANCE: 1,000 MΩ OR 50MΩ·μF PRODUCT WHICHEVER IS SMALLER					*150% Authorization Conditions CLASS II (A,B,F) 1005 C>0.47μF 1608 C ≥2.2μF 2012 C ≥4.7μF 3216 C ≥10.0μF 3225 C ≥22.0μF 4532 C ≥47.0μF 5750 C ≥100.0μF	
		(TWICE OF RATED VOLTAGE WILL BE APPLIED TO ALL SERIES BUT ABOVE) ** HOWEVER, A/B≧1005 C ≥0.22μF SEE (FIG.3)							
17	TEMPERATURE CYCLE	APPEARANCE	NO MECHANICAL DAMAGE SHALL OCCUR					CAPACITORS SHALL BE SUBJECTED TO FIVE CYCLES OF THE TEMPERATURE CYCLE AS FOLLOWING	
		CAPACITANCE	CHARACTERISTIC		CAP. CHANGE				
			CLASS I		WITHIN ±2.5% OR ±0.25pF WHICHEVER IS LARGER				
			CLASS II	A,B	WITHIN ±7.5%				
				F	WITHIN ±20%				
		Q CLASS I	30 pF AND OVER : Q ≥ 1000 LESS THAN 30pF:Q ≥400 +20×C					STEP TEMP.(℃) TIME(MIN) 1 MIN.RATED TEMP.+0/-3 30 2 25 2~3 3 MAX.RATED TEMP.+3/-0 30 4 25 2~3	
		Tanδ CLASS II	TO SATISFY THE SPECIFIED INITIAL VALUE						
INSULATION RESISTANCE	TO SATISFY THE SPECIFIED INITIAL VALUE								
		MEASURE AT ROOM TEMPERATURE AFTER COOLING FOR CLASS I : 24±2 Hr. CLASS II : 48±4 Hr.							

Multilayer Ceramic Capacitor

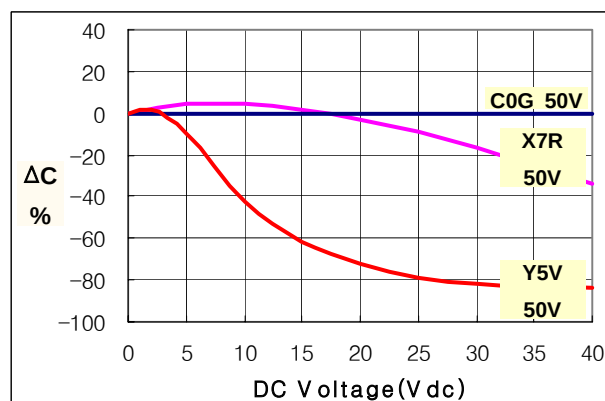
■ CHARACTERISTIC GRAPH

● ELECTRICAL CHARACTERISTICS

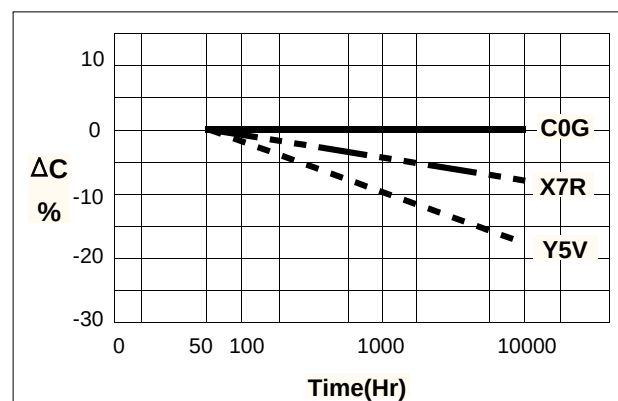
▶ CAPACITANCE - TEMPERATURE CHARACTERISTICS



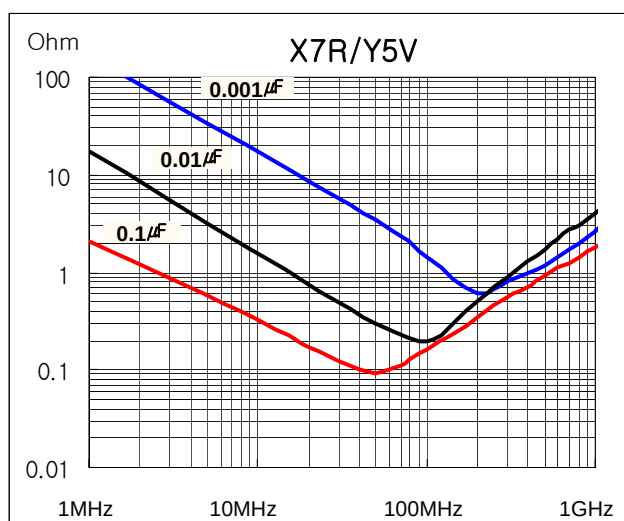
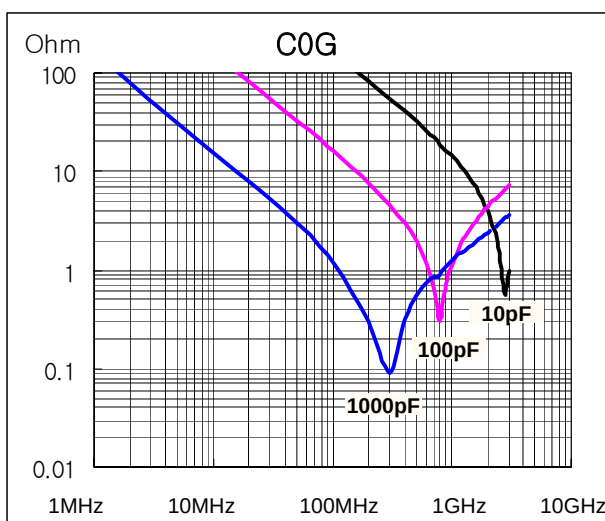
▶ CAPACITANCE - DC VOLTAGE CHARACTERISTICS



▶ CAPACITANCE CHANGE - AGING



▶ IMPEDANCE - FREQUENCY CHARACTERISTICS



Multilayer Ceramic Capacitor

■ APPLICATION MANUAL

● Storage Condition

▶ Storage Environment

The electrical characteristics of MLCCs were degraded by the environment of high temperature or humidity. Therefore, the MLCCs shall be stored in the ambient temperature and the relative humidity of less than 40°C and 70%, respectively. Guaranteed storage period is within 6 months from the outgoing date of delivery.

▶ Corrosive Gases

Since the solderability of the end termination in MLCC was degraded by a chemical atmosphere such as chlorine, acid or sulfide gases, MLCCs must be avoid from these gases.

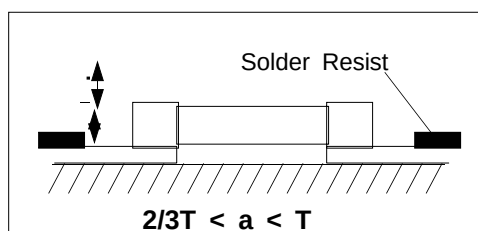
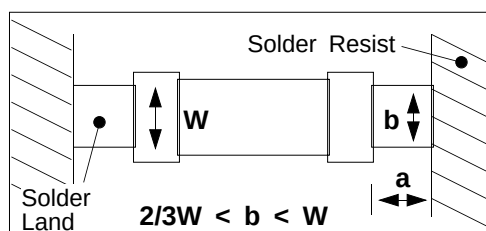
▶ Temperature Fluctuations

Since dew condensation may occur by the differences in temperature when the MLCCs are taken out of storage, it is important to maintain the temperature-controlled environment.

● Design of Land Pattern

When designing printed circuit boards, the shape and size of the lands must allow for the proper amount of solder on the capacitor. The amount of solder at the end terminations has a direct effect on the crack. The crack in MLCC will be easily occurred by the tensile stress which was due to too much amount of solder. In contrast, if too little solder is applied, the termination strength will be insufficiently. Use the following illustrations as guidelines for proper land design.

Recommendation of Land Shape and Size



● Adhesives

When flow soldering the MLCCs, apply the adhesive in accordance with the following conditions.

▶ Requirements for Adhesives

They must have enough adhesion, so that, the chips will not fall off or move during the handling of the circuit board.

They must maintain their adhesive strength when exposed to soldering temperature.

They should not spread or run when applied to the circuit board.

They should harden quickly.

They should not corrode the circuit board or chip material.

Multilayer Ceramic Capacitor

They should be a good insulator.

They should be non-toxic, and not produce harmful gases, nor be harmful when touched.

► Application Method

It is important to use the proper amount of adhesive. Too little and much adhesive will cause poor adhesion and overflow into the land, respectively.

► Adhesive hardening Characteristics

To prevent oxidation of the terminations, the adhesive must harden at 160°C or less, within 2 minutes or less.

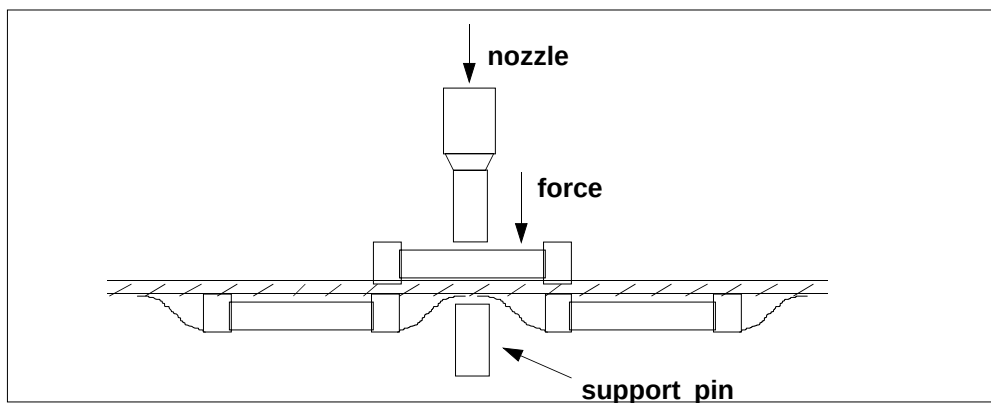
● Mounting

► Mounting Head Pressure

Excessive pressure will cause crack to MLCCs. The pressure of nozzle will be 300g maximum during mounting.

► Bending Stress

When double-sided circuit boards are used, MLCCs first are mounted and soldered onto one side of the board. When the MLCCs are mounted onto the other side, it is important to support the board as shown in the illustration. If the circuit board is not supported, the crack occur to the ready-installed MLCCs by the bending stress.



● Flux

Although the solderability increased by the highly-activated flux, increase of activity in flux may also degrade the insulation of the chip capacitors. To avoid such degradation, it is recommended that a mildly activated rosin flux(less than 0.2% chlorine) be used.

Multilayer Ceramic Capacitor

● Soldering

Since a multilayer ceramic chip capacitor comes into direct contact with melted solder during soldering, it is exposed to potentially mechanical stress caused by the sudden temperature change. The capacitor may also be subject to silver migration, and to contamination by the flux. Because of these factors, soldering technique is critical.

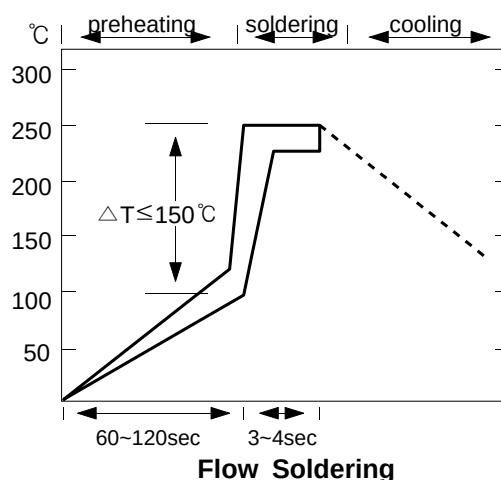
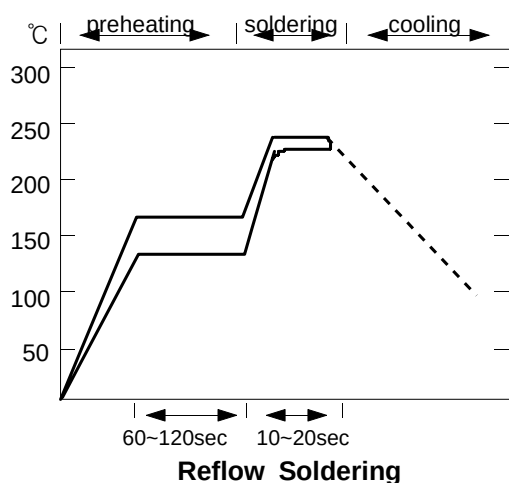
► Soldering Methods

Method	Classification	
Reflow soldering	- Overall heating	- Infrared rays - Hot plate - VPS(vapor phase)
	- Local heating	- Air heater - Laser - Light beam
Flow soldering	- Single wave - Double wave	-

* We recommend the reflow soldering method.

► Soldering Profile

To avoid crack problem by sudden temperature change, follow the temperature profile in the adjacent graph.

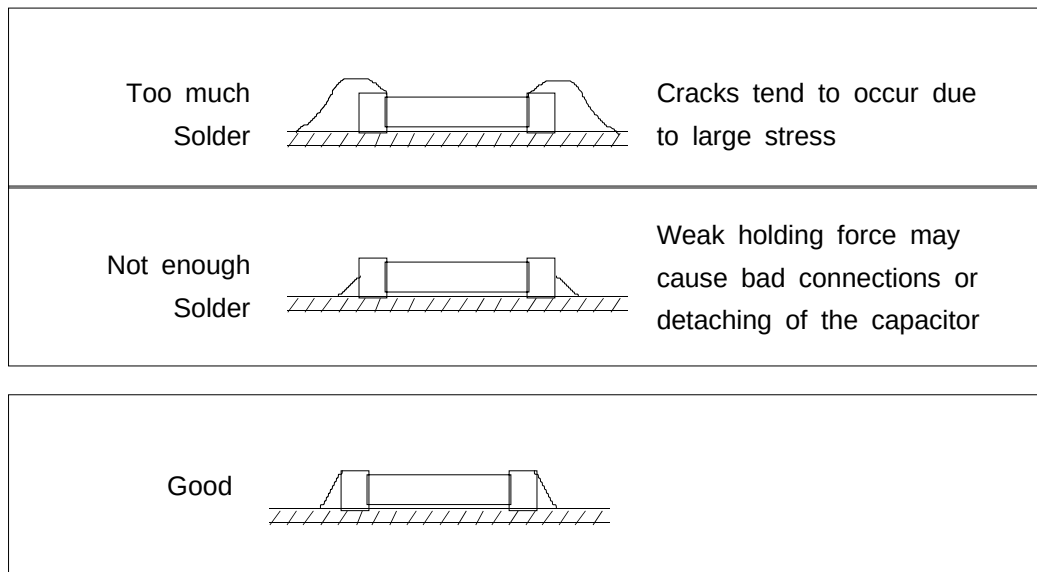


► Manual Soldering

Manual soldering can pose a great risk of creating thermal cracks in chip capacitors. The hot soldering iron tip comes into direct contact with the end terminations, and operator's carelessness may cause the tip of the soldering iron to come into direct contact with the ceramic body of the capacitor. Therefore the soldering iron must be handled carefully, and close attention must be paid to the selection of the soldering iron tip and to temperature control of the tip.

Multilayer Ceramic Capacitor

► Amount of Solder



► Cooling

Natural cooling using air is recommended. If the chips are dipped into solvent for cleaning, the temperature difference(ΔT) must be less than 100°C

6-6. Cleaning

If rosin flux is used, cleaning usually is unnecessary. When strongly activated flux is used, chlorine in the flux may dissolve into some types of cleaning fluids, thereby affecting the chip capacitors. This means that the cleaning fluid must be carefully selected, and should always be new.

► Notes for Separating Multiple, Shared PC Boards.

A multi-PC board is separated into many individual circuit boards after soldering has been completed. If the board is bent or distorted at the time of separation, cracks may occur in the chip capacitors. Carefully choose a separation method that minimizes the bending of the circuit board.

Multilayer Ceramic Capacitor

CROSS REFERENCE

P/N	COMPANY	SAMSUNG	AVX	JOHANSON	KEMET	KYOCERA	MURATA	NOVACAP	PANASONIC	ROHM	TAIYO - YUDEN	TDK	VITRAMON
① COMPANY	MODEL(MLCC)	CL	-	-	C	CM	GRM	-	ECJ	MCH	MK	C	VJ
② SIZE (EIA/JIS)	0201(0603)	03	-	-	-	03	33	-	Z	-	063	0603	-
	0402(1005)	05	0402	R07	0402	05	36	0402	0	15	105	1005	0402
	0603(1608)	10	0603	R14	0603	105	39	0603	1	18	107	1608	0603
	0805(2012)	21	0805	R15	0805	21	40	0805	2	21	212	2012	0805
	1206(3216)	31	1206	R18	1206	316	42-6	1206	3	31	316	3216	1206
	1210(3225)	32	1210	S41	1210	32	42-2	1210	4	32	325	3225	1210
	1808(4520)	42	1808	R29	1808	42	-	1808	-	-	-	4520	1808
	1812(4532)	43	1812	S43	1812	43	43-2	1812	-	43	432	4532	1812
	2220(5750)	55	-	-	2220	55	44-1	2221	-	-	550	5650	-
③ TEMPERATURE CHARACTERISTIC	COG(NPO)	C	A	N	G	CG	COG/CH	N	C	A	C	COG/CH	A
	P2H(N150)	P	S	-	-	P	P2H	-	P	-	P	PH	-
	R2H(N220)	R	1	-	-	R	R2H	-	R	-	R	RH	-
	S2H(N330)	S	3	-	-	S	S2H	-	S	-	S	SH	-
	T2H(N470)	T	O	-	-	T	T2H	-	T	-	T	TH	-
	U2J(N750)	U	Z	-	-	U	U2J	-	U	UJ	U	UJ	-
	S2L	L	Y	-	-	SL	SL	-	G	SL	SL	SL	-
	X7R	B	C	W	R(X)	X7R	X7R	B	B	C	BJ	X7R(B)	Y(X)
	Z5U	E	E	Z	U	-	Z5U	Z	-	E	-	Z5U	U
	Y5V	F	G	Y	V	Y5V	Y5V	Y	F	F	F	Y5V	-
④ NOMINAL CAPACITANCE		EX) 103=10,000pF 221=220pF 225=2,200,000pF=2.2μF 1R5=1.5pF 010=1pF											
⑤ CAPACITANCE TOLERANCE		B:±0.1pF C:±0.25pF D:±0.5pF F:±1% G:±2% J:±5% K:±10% M:±20% Z:-20~+80%											
⑥ RATED VOLTAGE	6.3V	Q	6	-	9	06	6.3	-	0J	-	J	0J	-
	10 V	P	Z	100	8	10	10	-	1A	4	L	1A	-
	16 V	O	Y	160	4	16	16	160	1C	3	E	1C	J
	25 V	A	3	250	3	25	25	250	1E	2	T	1E	X
	50 V	B	5	500	5	50	50	500	1H	5	U	1H	A
	100 V	C	1	101	1	100	100	101	2A	1	-	2A	B
	200V	D	2	201	2	200	200	201	2D	-	-	-	C
	250V	E	V	-	-	250	250	251	-	-	-	2E	-
	500V	G	7	501	-	500	500	501	-	-	-	-	E
	630V	H	-	-	-	630	630	-	-	-	-	2J	-
	1000V	I	A	102	-	1000	1K	102	-	-	-	3A	G
	2000V	J	G	202	-	2000	2K	202	-	-	-	3D	-
	3000V	K	H	302	-	3000	3K	302	-	-	-	3F	H
	4000V	-	J	-	-	4000	-	402	-	-	-	-	-
⑦ TERMINATION	NICKEL BARRIER	N	T	V	C	A	(GRM)	N	-	(MCH)	-	-	X
	Ag/Pd	P	1	-	-	B	(GR)	P	-	(MC)	-	-	F
⑧ PACKAGE	BULK(VINYL)	B	9	(NONE)	-	B	PB	*	X	-	B	B	B
	PAPER TAPING	C	2, 4	T, R	-	T, L	PT	T	E,V,W	K, L	T	T	C, P
	PLASTIC TAPING	E	1, 3	E, U	-	H, N	PT	-	F, Y	P, Q	T	-	T, R
	BULK CASE	P	7	-	-	C	PC	-	C	C	-	-	G

Multilayer Ceramic Capacitor

► SAMSUNG : CL10B104KA8NNNC

CL	10	B	104	K	A	8	N	N	N	C
Series	Size	Dielectric	Capacitance	Tolerance	Voltage	Thickness	Electrode/ Termination/ Plating	Products	Special	Packaging
03 = 0201 05 = 0402 10 = 0603 21 = 0805 31 = 1206 32 = 1210 43 = 1812 55 = 2220	C = C0G P = P2H R = R2H S = S2H T = T2H U = U2H L = S2L B = X7R A = X5R F = Y5V	2 significant figures + number of zeros Use "R" for decimal point	A = ±0.05pF B = ±0.1pF C = ±0.25pF D = ±0.5pF F = ±1% G = ±2% J = ±5% K = ±10% M = ±20% Z = +80,-20%	Q = 6.3V P = 10V O = 16V A = 25V B = 50V C = 100V D = 200V E = 250V G = 500V H = 630V I = 1000V	3 = 0.30 5 = 0.50 8 = 0.80 A = 0.65 C = 0.85 H = 1.60 I = 2.00 J = 2.50 L = 3.20	A = Pd/Ag/ Sn 100% N = Ni/Cu/ Sn 100% G = Cu/Cu/ Sn 100%	A = Array (2-element) B = Array (4-element) C = High - Q L = LICC N = Normal P = Automotive W = 3 terminal chip	Various	B = Bulk P = Cassette C = Paper 7" D = Paper 13" (10,000EA) E = Embossing 7" F = Embossing 13" L = Paper 13" (15,000EA) O = Paper 10" S = Embossing 10"	

► AVX : 06033C104KAT2A

0603	3	C	104	K	A	T	2	A
Size	Voltage	Dielectric	Capacitance	Tolerance	Failure Rate	Termination	Packaging	Special
0201 0402 0603 0805 1206 1210 1812 2220 2225	4 = 4V 6 = 6.3V Z = 10V Y = 16V 3 = 25V B = 50V C = 100V D = 200V E = 250V G = 500V I = 1000V	A = C0G C = X7R D = X5R E = Z5U G = Y5V	2 significant figures + number of zeros Use "R" for decimal point	B = $\pm 0.1\text{pF}$ C = $\pm 0.25\text{pF}$ D = $\pm 0.5\text{pF}$ F = $\pm 1\%$ G = $\pm 2\%$ J = $\pm 5\%$ K = $\pm 10\%$ M = $\pm 20\%$ Z = $+80, -20\%$ P = GMV,+100,-0%	A = N/A	T = Sn 100% 7 = Gold Plated 1 = Pd/Ag	2 = 7" Reel 4 = 13" Reel 7 = Cassette 9 = Bulk	A = Standard T = 0.66mm S = 0.56mm R = 0.46mm

► JOHANSON : 250R14W104KV6T

250	R14	W	104	K	V	6	T
Voltage	Size	Dielectric	Capacitance	Tolerance	Termination	Marking	Packaging
2 significant figures + number of zeros	R07 = 0402 R14 = 0603 R15 = 0805 R18 = 1206 S41 = 1210 S43 = 1812 S47 = 2220 S48 = 2225 S49 = 1825 S54 = 3640	N = C0G W = X7R X = X5R Z = Z5U Y = Y5V	2 significant figures + number of zeros Use "R" for decimal point	B = $\pm 0.1\text{pF}$ C = $\pm 0.25\text{pF}$ D = $\pm 0.5\text{pF}$ F = $\pm 1\%$ G = $\pm 2\%$ J = $\pm 5\%$ K = $\pm 10\%$ M = $\pm 20\%$ Z = $+80, -20\%$ P = GMV,+100,-0%	V = Ni Barrier	4 = No Mark 6 = Marking	E = 7" Reel Plastic T = 7" Reel Paper R = 13" Reel Paper U = 13" Reel Plastic None = Bulk

► KEMET : C0603C104K3RAC

<u>C</u>	<u>0603</u>	<u>C</u>	<u>104</u>	<u>K</u>	<u>3</u>	<u>R</u>	<u>A</u>	<u>C</u>
Series	Size	Specification	Capacitance	Tolerance	Voltage	Dielectric	Failure Rate	Termination
0402	C = Standard	2	B = ±0.1pF	9 = 6.3V	G = C0G	A = Standard	C = Ni w/Tin Plate	
0603	A = GR900	significant	C = ±0.25pF	8 = 10V	R = X7R	M = 1.0 (Mil)	H = Ni w/Solder	
0805	P = Mil-C-55681	figures	D = ±0.5pF	4 = 16V	P = X5R	P = 0.1 (Mil)	T = Silver	
1206	CDR01-CDR06	+	F = ±1%	3 = 25V	U = Z5U	R = 0.01 (Mil)	G = Gold Plated	
1210	N = Mil-C-55681	number	G = ±2%	5 = 50V	X = BX(Mil)	S = 0.001 (Mil)		
1812	CDR31-CDR35	of zeros	J = ±5%	1 = 100V	V = Y5V			
2220	Z = Mil-C-123	Use "R" for	K = ±10%	2 = 200V				
2225	E = Mil Equivalent	decimal point	M = ±20%					
	(Group A Only)		Z = +80, -20%					
			P = +100, 0%					

Multilayer Ceramic Capacitor

► KYOCERA : CM105X7R104K25AT

CM	105	X7R	104	K	25	A	T
Series	Size	Dielectric	Capacitance	Tolerance	Voltage	Termination	Packaging
03 = 0201 05 = 0402 105 = 0603 21 = 0805 316 = 1206 32 = 1210 42 = 1808 43 = 1812 55 = 2220	CG X8R X7R X5R Z5U Y5V Y5U	2 significant figures + number of zeros Use "R" for decimal point	B = ±0.1pF C = ±0.25pF D = ±0.5pF F = ±1% G = ±2% J = ±5% K = ±10% M = ±20% Z = +80, -20% P = +100, 0%	04 = 4V 06 = 6.3V 10 = 10V 16 = 16V 25 = 25V 50 = 50V 100 = 100V 250 = 250V 500 = 500V 1000 = 1000V	A = Ni Barrier	T = 7" Reel (4mm Pitch) L = 13" Reel (4mm Pitch) H = 7" Reel (2mm Pitch) N = 13" Reel (2mm Pitch) B = Bulk (Vinyl Bags) C = Bulk Cassette	

► MURATA : GRM188R71E104KA01D

GRM	18	8	R7	1E	104	K	A01	D
Series	Size	Thickness	Dielectric	Voltage	Capacitance	Tolerance	Individual Specification Code	Packaging
Ni Barrier	03 = 0201 15 = 0402 18 = 0603 21 = 0805 31 = 1206 32 = 1210 42 = 1808 43 = 1812 55 = 2220	3 = 0.3mm 5 = 0.5mm 8 = 0.8mm A = 1.0mm B = 1.25mm C = 1.6mm D = 2.0mm E = 2.5mm F = 3.2mm	5C = C0G R7 = X7R R6 = X5R E4 = Z5U F5 = Y5V	0J = 6.3V 1A = 10V 1C = 16V 1E = 25V 1H = 50V 2A = 100V 2E = 250V 2H = 500V 3A = 1000V	2 significant figures + number of zeros Use "R" for decimal point	B = $\pm 0.1\text{pF}$ C = $\pm 0.25\text{pF}$ D = $\pm 0.5\text{pF}$ F = $\pm 1\%$ G = $\pm 2\%$ J = $\pm 5\%$ K = $\pm 10\%$ M = $\pm 20\%$ Z = +80,-20% P = +100, 0%		D = 7" Reel Paper L = 7" Reel Plastic J = 13" Reel Paper K = 13" Reel Plastic B = Bulk C = Bulk Cassette T = Bulk Tray

► NOVACAP : 0603B104K250N_TM

1206	B	104	K	250	N	-	T	M
Size	Dielectric	Capacitance	Tolerance	Voltage	Termination	Thickness	Packaging	Marking
0402 0603 0805 1005 1206 1210 1808 1812 2220	N = C0G B = X7R X = BX Z = Z5U Y = Y5V	2 significant figures + number of zeros Use "R" for decimal point	B = $\pm 0.1\text{pF}$ C = $\pm 0.25\text{pF}$ D = $\pm 0.5\text{pF}$ F = $\pm 1\%$ G = $\pm 2\%$ J = $\pm 5\%$ K = $\pm 10\%$ M = $\pm 20\%$ Z = +80,-20% P = +100, 0%	2 significant figures + number of zeros	P = Pd/Ag N = Ni Barrier (Sn 100%) Y = Ni Barrier (Sn/Pb)	Per Specified	T = Reel None = Bulk W = Waffle Pack	

► PANASONIC : ECJ1EB1E104K

ECJ	1	E	B	1E	104	K
Series	Size	Packaging	Dielectric	Voltage	Capacitance	Tolerance
	Z = 0201 0 = 0402 1 = 0603 2 = 0805 3 = 1206 4 = 1210	X = Bulk E = Paper 2mm V = Paper 4mm F, Y = Plastic 4mm W = Large Reels 2mm Z = Large Reels 4mm C = Bulk Cassette	C = C0G B = X7R, X5R F = Y5V	0J = 6.3V 1A = 10V 1C = 16V 1E = 25V 1H = 50V 2A = 100V 2D = 200V	2 significant figures + number of zeros Use "R" for decimal point	C = $\pm 0.25\text{pF}$ D = $\pm 0.5\text{pF}$ F = $\pm 1\%$ J = $\pm 5\%$ K = $\pm 10\%$ M = $\pm 20\%$ Z = +80, -20%

Multilayer Ceramic Capacitor

► ROHM : MCH182C104KKN

<u>MCH</u>	<u>18</u>	<u>2</u>	<u>C</u>	<u>104</u>	<u>K</u>	<u>K</u>	<u>N</u>
Series	Size	Voltage	Dielectric	Capacitance	Tolerance	Packaging	Marking/Thickness
	15 = 0402 18 = 0603 21 = 0805 31 = 1206 32 = 1210 43 = 1812	4 = 10V 3 = 16V 2 = 25V 5 = 50V	A = C0G C = X7R F = Y5V	2 significant figures + number of zeros Use "R" for decimal point	B = $\pm 0.1\text{pF}$ C = $\pm 0.25\text{pF}$ D = $\pm 0.5\text{pF}$ F = $\pm 1\%$ G = $\pm 2\%$ J = $\pm 5\%$ K = $\pm 10\%$ M = $\pm 20\%$ Z = $+80, -20\%$ P = $+100, 0\%$	K = 7" Reel Paper P = 7" Reel Plastic L = 13" Reel Paper Q = 13" Reel Plastic B = Bulk C = Bulk Cassette	N = Marked Special Thickness

► TAIYO-YUDEN : TMK107BJ104K_T

<u>T</u>	<u>M</u>	<u>K</u>	<u>107</u>	<u>BJ</u>	<u>104</u>	<u>K</u>	<u>-</u>	<u>T</u>
Voltage	Type	Termination	Size	Dielectric	Capacitance	Tolerance	Special	Packaging
A = 4V J = 6.3V L = 10V E = 16V T = 25V U = 50V	M = Multilayer V = Hi Q	K = Ni Barrier	105 = 0402 107 = 0603 212 = 0805 316 = 1206 325 = 1210 432 = 1812 550 = 2220	CG = C0G CH = C0H CJ = C0J CK = C0K BJ = X5R, X7R F = Y5V	2 significant figures + number of zeros Use "R" for decimal point	C = $\pm 0.25\text{pF}$ D = $\pm 0.5\text{pF}$ F = $\pm 1\%$ G = $\pm 2\%$ J = $\pm 5\%$ K = $\pm 10\%$ M = $\pm 20\%$ Z = $+80, -20\%$	Various	T = Reel B = Bulk

► TDK : C1608X7R1E104KT

<u>C</u>	<u>1608</u>	<u>X7R</u>	<u>1E</u>	<u>104</u>	<u>K</u>	<u>T</u>
Series	Size	Dielectric	Voltage	Capacitance	Tolerance	Packaging
	0603 = 0201 1005 = 0402 1608 = 0603 2012 = 0805 3216 = 1206 3225 = 1210 4532 = 1812 5650 = 2220	CG X7R Z5U Y5V	0J = 6.3V 1A = 10V 1C = 16V 1E = 25V 1H = 50V	2 significant figures + number of zeros Use "R" for decimal point	C = $\pm 0.25\text{pF}$ D = $\pm 0.5\text{pF}$ F = $\pm 1\%$ G = $\pm 2\%$ J = $\pm 5\%$ K = $\pm 10\%$ M = $\pm 20\%$ Z = $+80, -20\%$	T = Reel B = Bulk

► VITRAMON : VJ0603Y104KXXMC

<u>VJ</u>	<u>0603</u>	<u>Y</u>	<u>104</u>	<u>K</u>	<u>X</u>	<u>X</u>	<u>M</u>	<u>C</u>
Series	Size	Dielectric	Capacitance	Tolerance	Termination	Voltage	Marking	Packaging
	0402 0603 0805 1206 1210 1812 2225	X = BX A,N = C0G Y = X7R U = Z5U H = X8R	2 significant figures + number of zeros Use "R" for decimal point	B = $\pm 0.1\text{pF}$ C = $\pm 0.25\text{pF}$ D = $\pm 0.5\text{pF}$ F = $\pm 1\%$ G = $\pm 2\%$ J = $\pm 5\%$ K = $\pm 10\%$ M = $\pm 20\%$ Z = $+80, -20\%$ P = $+100, 0\%$	X = Silver, Ni Barrier Tin Plated	J = 16V X = 25V A = 50V B = 100V C = 200V	M = Marking A = No Marking	C = 7" Reel Paper T = 7" Reel Plastic P = 13" Reel Paper R = 13" Reel Plastic B = Bulk



Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



Как с нами связаться

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